

AO3406

N-Channel Enhancement Mode Field Effect Transistor

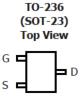


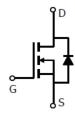
General Description

The AO3406 uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO3406 is Pb-free (meets ROHS & Sony 259 specifications). AO3406L is a Green Product ordering option. AO3406 and AO3406L are electrically identical.

Features

$$\begin{split} &V_{DS}\left(V\right) = 30V \\ &I_{D} = 3.6A \; \left(V_{GS} = 10V\right) \\ &R_{DS(ON)} < 65 m\Omega \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 105 m\Omega \; (V_{GS} = 4.5V) \end{split}$$





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	30	V				
Gate-Source Voltage		V_{GS}	±20	V				
Continuous Drain	T _A =25°C		3.6					
Current ^A	T _A =70°C	I_D	2.9	Α				
Pulsed Drain Current ^B		I _{DM}	15					
	T _A =25°C	В	1.4	10/				
Power Dissipation ^A	T _A =70°C	P_{D}	0.9	W				
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s	€ 10s R _{θJA}		90	°C/W			
Maximum Junction-to-Ambient A	Steady-State	R _θ JA	100	125	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	63	80	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Parameter Conditions		Тур	Max	Units			
STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	I_D =250μA, V_{GS} =0V	30			V			
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V			1				
		T _J =55°C			5	μА			
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±20V			100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	1	1.9	3	V			
$I_{D(ON)}$	On state drain current	V_{GS} =10V, V_{DS} =5V	15			Α			
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.6A		50	65	mΩ			
		T _J =125°C		74	100	11122			
		V_{GS} =4.5V, I_{D} =2.8A		75	105	mΩ			
g _{FS}	Forward Transconductance	V_{DS} =5V, I_D =3.6A		7		S			
V_{SD}	Diode Forward Voltage	I _S =1A		0.79	1	V			
I _S	Maximum Body-Diode Continuous Current				2.5	Α			
DYNAMIC	PARAMETERS	•		-		-			
C _{iss}	Input Capacitance			288	375	pF			
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz		57		pF			
C_{rss}	Reverse Transfer Capacitance			39		pF			
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		3	6	Ω			
SWITCHIN	NG PARAMETERS								
$Q_g(10V)$	Total Gate Charge			6.5	8.5	nC			
$Q_g(4.5V)$	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =3.6A		3.1	4	nC			
Q_{gs}	Gate Source Charge	VGS-10V, VDS-10V, ID-0.0A		1.2		nC			
Q_{gd}	Gate Drain Charge			1.6		nC			
t _{D(on)}	Turn-On DelayTime			4.6		ns			
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =2.2 Ω ,		1.9		ns			
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		20.1		ns			
t _f	Turn-Off Fall Time] [2.6		ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =3.6A, dI/dt=100A/μs		10.2	14	ns			
Q_{rr}	Body Diode Reverse Recovery Charge I _F =3.6A, dI/dt=100A/μs			3.5		nC			

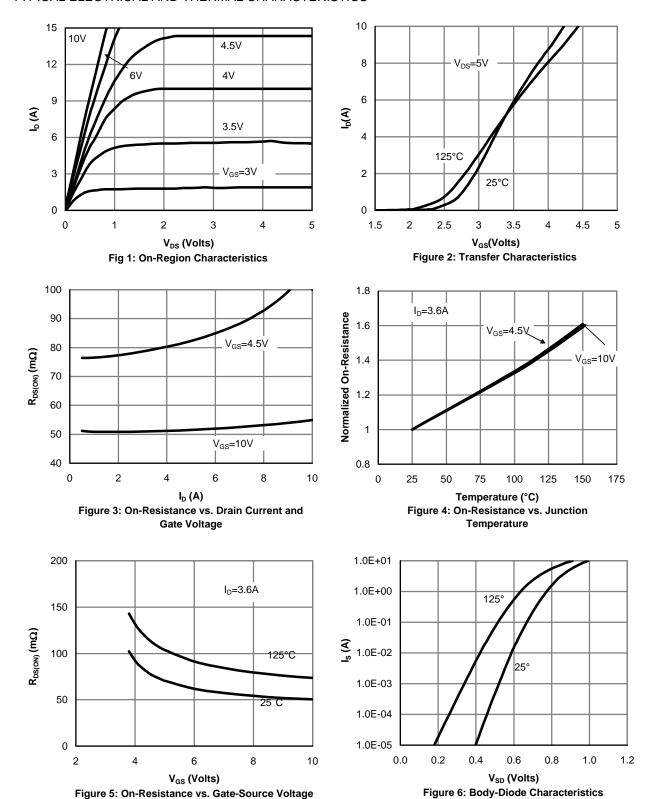
A: The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

- B: Repetitive rating, pulse width limited by junction temperature.
- C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.
- D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\,\mu s$ pulses, duty cycle 0.5% max.
- E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

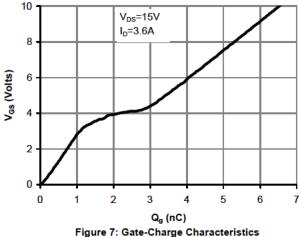
Rev 5 : July 2005

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



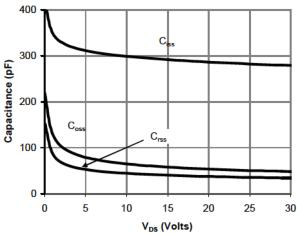


Figure 8: Capacitance Characteristics

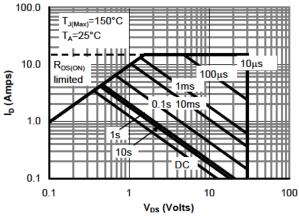


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

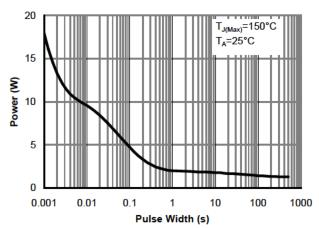


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

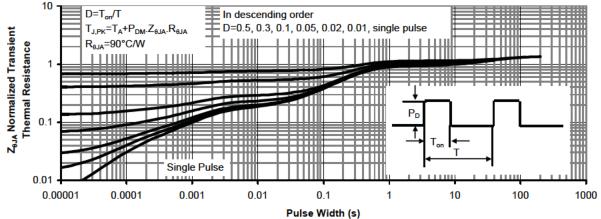


Figure 11: Normalized Maximum Transient Thermal Impedance